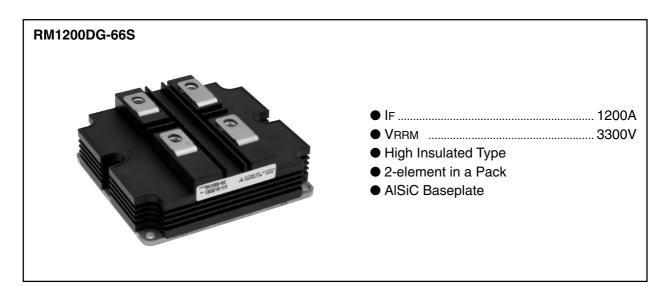
MITSUBISHI HIGH VOLTAGE DIODE MODULE

RM1200DG-66S

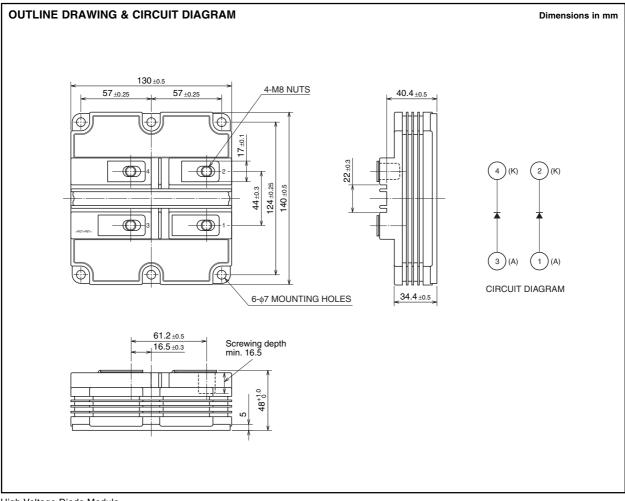
HIGH POWER SWITCHING USE INSULATED TYPE

High Voltage Diode Module



APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers





RM1200DG-66S

HIGH POWER SWITCHING USE INSULATED TYPE

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MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
VRRM	Repetitive peak reverse voltage	Tj = 25 °C	3300	V
VRSM	Non-repetitive peak reverse voltage	Tj = 25 °C	3300	V
VR(DC)	Reverse DC voltage	Tj = 25 °C	2200	V
lF	DC forward current	Tc = 25 °C	1200	A
IFSM	Surge forward current	Tj = 25 °C start, tw = 8.3 ms Half sign wave	9600	Α
l ² t	Current-squared, time integration	Tj = 25 °C start, tw = 8.3 ms Half sign wave	384	kA ² s
Viso	Isolation voltage	Charged part to the baseplate RMS sinusoidal, 60Hz 1min.	10200	V
Ve	Partial discharge extinction voltage	RMS sinusoidal, 60Hz, QPD ≤ 10PC	5100	V
Tj	Junction temperature	_	-40 ~ +150	°C
Тор	Operating temperature	_	-40 ~ +125	°C
Tstg	Storage temperature	—	-40 ~ +125	°C

ELECTRICAL CHARACTERISTICS

Symbol	ltom	Conditions		Limits			Unit
Symbol	Item			Min	Тур	Max	Unit
IRRM	Repetitive reverse current	VRM = VRRM	Tj = 25 °C	—	—	5	mA
			Tj = 125 °C	—	3	30	
Vfm	Forward voltage (Note 1)	IF = 1200 A	Tj = 25 °C	—	2.80	_	v
			Tj = 125 °C	_	2.70	_	v
trr	Reverse recovery time	VR = 1650 V, IF = 1200 A di/dt = -4000 A/μs Ls=100nH, Tj = 125 °C		—	1.0	_	μs
Irr	Reverse recovery current			_	1600	_	Α
Qrr	Reverse recovery charge			_	800	_	μC
Erec	Reverse recovery energy (Note 2)			_	0.9	_	J/P

Note 1. It doesn't include the voltage drop by internal lead resistance. 2. Erec is the integral of 0.1VR x 0.1Irr x dt.



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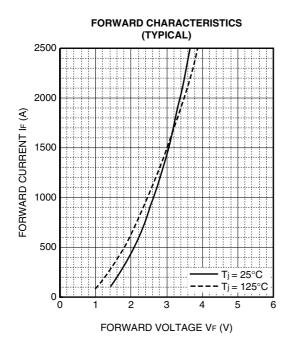
THERMAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Linit
Symbol		Conditions	Min	Тур	Max	Unit
Rth(j-c)	Thermal resistance	Junction to case (per 1/2 module)	—	_	18.0	K/kW
Rth(c-f)	Contact thermal resistance	Case to Fin, λgrease = 1W/m·K D(c-f)=100μm, (per 1/2 module)	_	16.0	—	K/kW

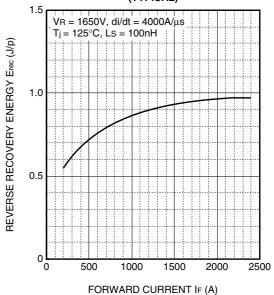
MECHANICAL CHARACTERISTICS

Symbol	Item	Que altriana	Limits			Linit
		Conditions	Min	Тур	Max	Unit
Mt	Mounting torque	M8: Main terminals screw	7.0	—	15.0	N∙m
Ms	Mounting torque	M6: Mounting screw	3.0	—	6.0	N∙m
m	Mass	—	_	1.0	_	kg
CTI	Comparative tracking index	—	600	—	—	—
Da	Clearance	—	26	—	—	mm
Ds	Creepage distance	—	56	—	—	mm
LP CE	Internal inductance	—	—	44	_	nH
RCC'+EE'	Internal lead resistance	Tc = 25 °C	_	0.27	_	mΩ

PERFORMANCE CURVES



REVERSE RECOVERY ENERGY CHARACTERISTICS (TYPICAL)

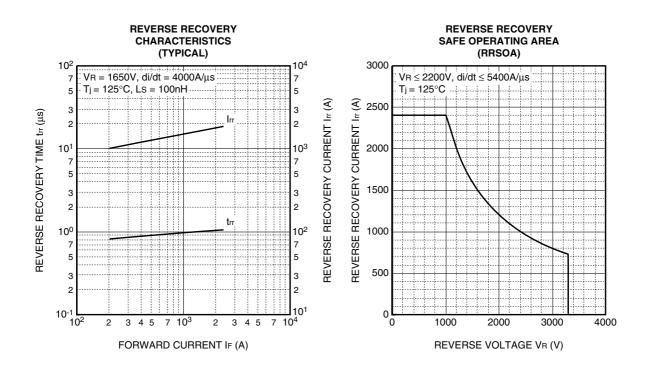


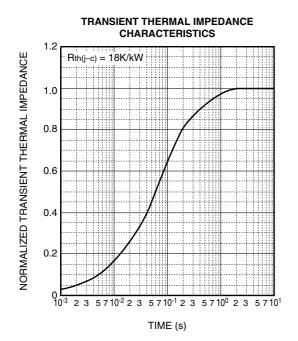


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$Z_{ih(j-c)}(t) = \sum_{i=1}^{n} R_{i} \left\{ 1 - exp^{\left(-\frac{t}{\tau_{i}}\right)} \right\}$								
	1	2	3	4				
R _i [K/kW]	0.0059	0.0978	0.6571	0.2392				
$\tau_i [\text{sec}]$	0.0002	0.0074	0.0732	0.4488				



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